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Dated: August 19, 2002

Signature: [Signature]  
(Marcus J. Millet)

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10/16/2  
Docket No.: TESSERA 3.0-299 (PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:  
Damberg et al.

Application No.: 10/044,121

Group Art Unit: 281

Filed: January 11, 2002

Examiner: Not Yet Assigned

For: STACKED MICROELECTRONIC  
ASSEMBLIES AND METHODS OF  
MAKING SAME

Commissioner for Patents  
Washington, DC 20231

INFORMATION DISCLOSURE STATEMENT

Dear Sir:

It is respectfully requested that the references listed on the enclosed form be made of record and considered with respect to the above-referenced U.S. patent application. A copy of each reference is enclosed. Submission of the present Information Disclosure Statement should not be taken as an admission that the cited references are legally available prior art or that the same are pertinent or material.

In the event that any fee is due in connection with the present Information Disclosure Statement, the Commissioner is hereby authorized to charge the same to our Deposit Account No. 12-1095.

Dated: August 19, 2002

Respectfully submitted,

By [Signature]  
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